

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
40V	2.9mΩ@10V	75A
	4.2mΩ@4.5V	



合肥矽普半导体

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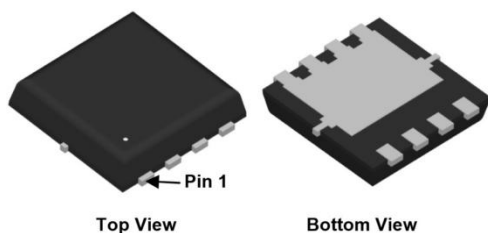
Feature

- Fast switching speed
- Low Gate Charge and Rdson
- Advanced Split Gate Trench Technology
- 100% Single Pulse avalanche energy Test

Applications

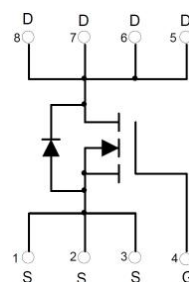
- DC-DC Converters
- Motor Control
- Portable equipment application

Package

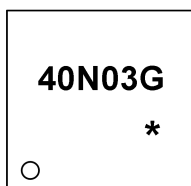


PDFN3X3-8L

Circuit diagram



Marking



40N03G
*

:Device Code
:Month Code

Order Information

Device	Package	Unit/Tape
SP40N03GNJ	PDFN3X3-8L	5000

Absolute maximum ratings (Ta=25°C, unless otherwise noted)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DSS}	40	V
Gate-Source Voltage	V_{GSS}	± 20	V
Continuous Drain Current (Tc=25°C)	I_D	75	A
Continuous Drain Current (Tc=100°C)	I_D	50	A
Pulse Drain Current Tested	I_{DM}	300	A
Single pulsed avalanche energy ¹	E_{AS}	169	mJ
Power Dissipation (Tc=25°C)	P_D	55	W
Power Dissipation (Tc=100°C)	P_D	22	W
Thermal Resistance Junction-to-Case	$R_{\theta JC}$	2.27	°C/W
Storage Temperature Range	T_{STG}	-55 to 150	°C
Operating Junction Temperature Range	T_J	-55 to 150	°C

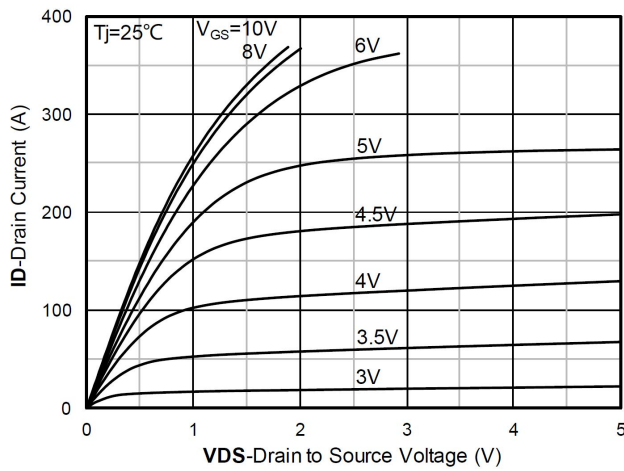
Electrical characteristics (Ta=25°C, unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	VGS=0V , ID=250uA	40	-	-	V
Drain-Source Leakage Current	IDSS	VDS=32V , VGS=0V , TJ=25℃	-	-	1	uA
Gate-Source Leakage Current	IGSS	VGS=±20V , VDS=0V	-	-	±100	nA
Gate Threshold Voltage	VGS(th)	VGS=VDS , ID=250uA	1.1	1.5	2.1	V
Static Drain-Source On-Resistance	RDS(ON)	VGS=10V , ID=20A	-	2.9	3.7	mΩ
		VGS=4.5V , ID=10A	-	4.2	5.6	
Gate Resistance	RG	VDS=20V , VGS=0V , f=1MHz	-	3.4	-	Ω
Dynamic characteristics						
Input Capacitance	Ciss	VDS=20V , VGS=0V , f=1MHz	-	2398	-	pF
Output Capacitance	Coss		-	441	-	
Reverse Transfer Capacitance	Crss		-	17	-	
Total Gate Charge	Qg	VDS=20V , VGS=10V , ID=30A	-	37	-	nC
Gate-Source Charge	Qgs		-	11.5	-	
Gate-Drain Charge	Qgd		-	8	-	
Gate Plateau Voltage	Vplateau		-	3.65	-	V
Switching Characteristics						
Turn-On Delay Time	Td(on)	VDD=20 , VGS=10V , RG=3Ω , ID=30A	-	11.5	-	nS
Rise Time	Tr		-	8	-	
Turn-Off Delay Time	Td(off)		-	46	-	
Fall Time	Tf		-	9	-	
Diode Characteristics						
Diode Forward Voltage	VSD	VGS=0V , IS=1A , TJ=25℃	-	-	1.2	V
Diode Continuous Current	Is		-	-	75	A
Reverse recover time	Trr	IS=20A , di/dt=100A/us , Tj=25℃	-	14	-	nS
Reverse recovery charge	Qrr		-	23	-	nC

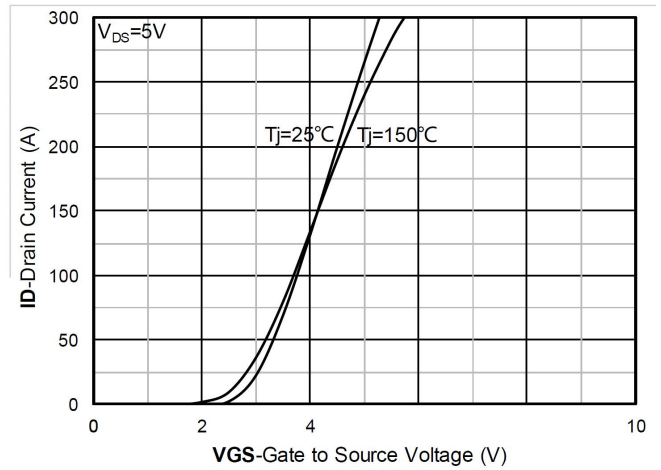
Note:

- The EAS test condition is $V_{DD}=20V, V_{GS}=10V, L=0.5mH, R_G=25\Omega$

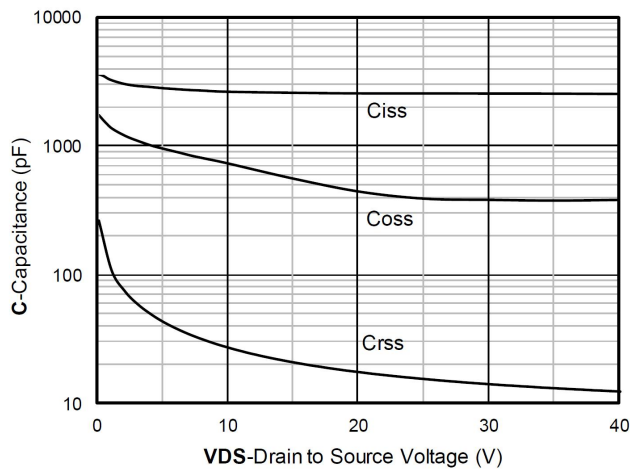
Typical Characteristics



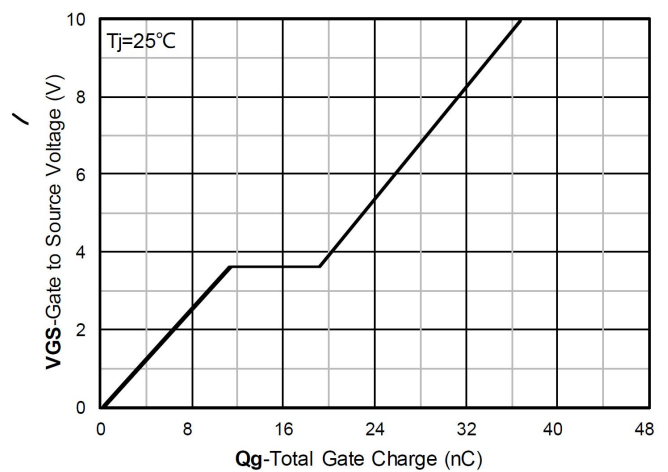
Output Characteristics



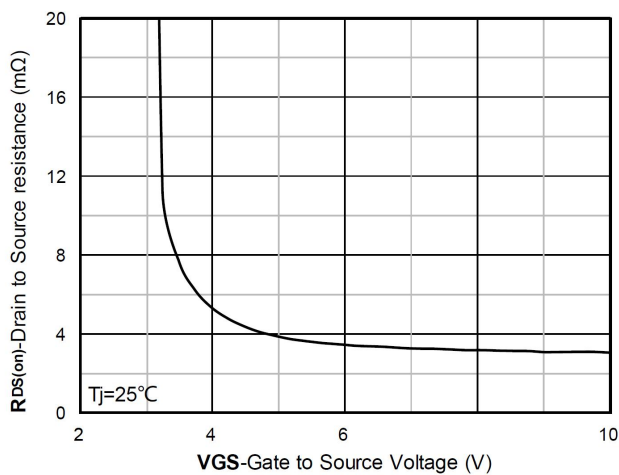
Transfer Characteristics



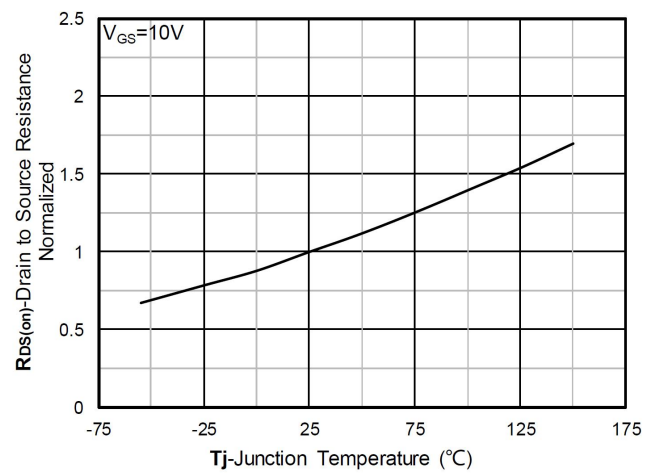
Capacitance Characteristics



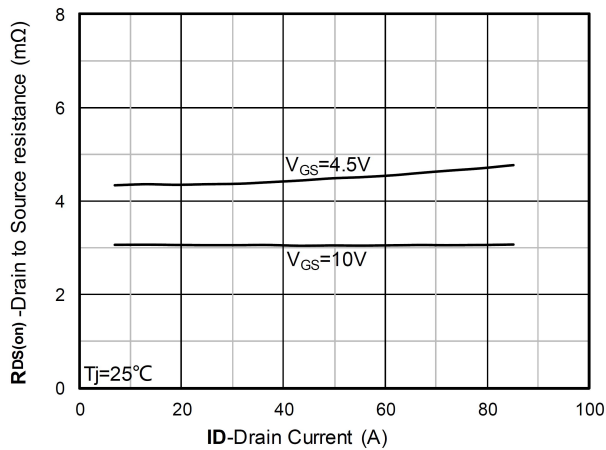
Gate Charge



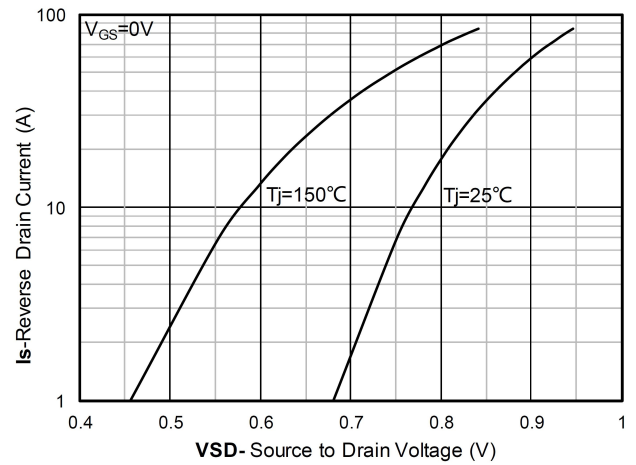
On-Resistance vs. Gate to Source Voltage



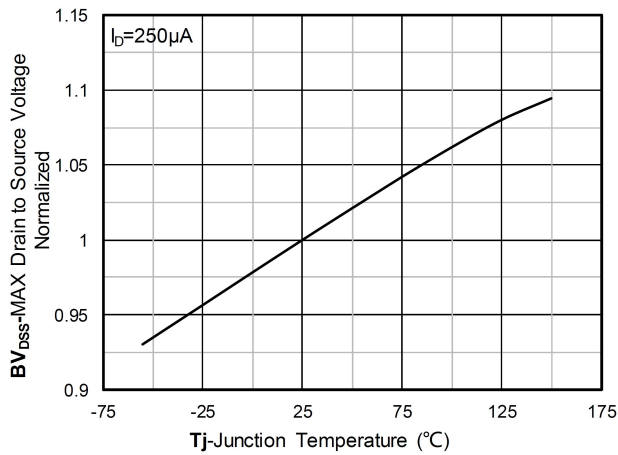
Normalized On-Resistance



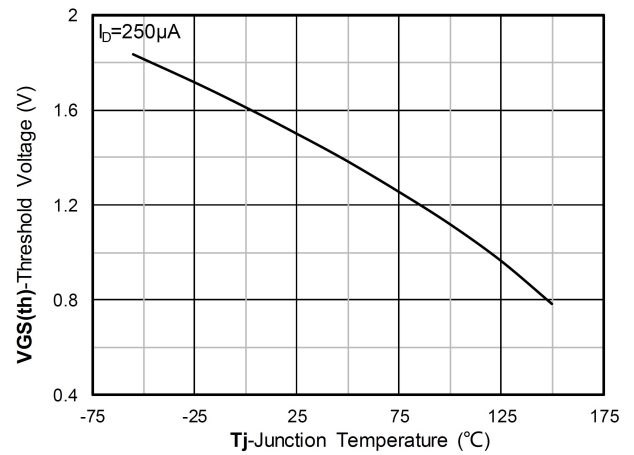
RDS(on) vs. Drain Current



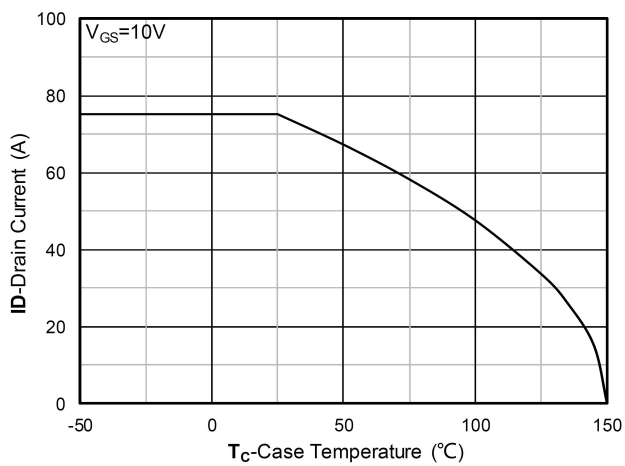
Forward characteristics of reverse diode



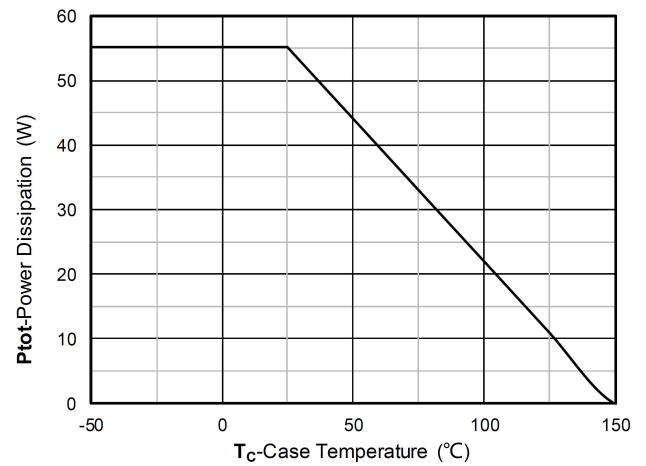
Normalized breakdown voltage



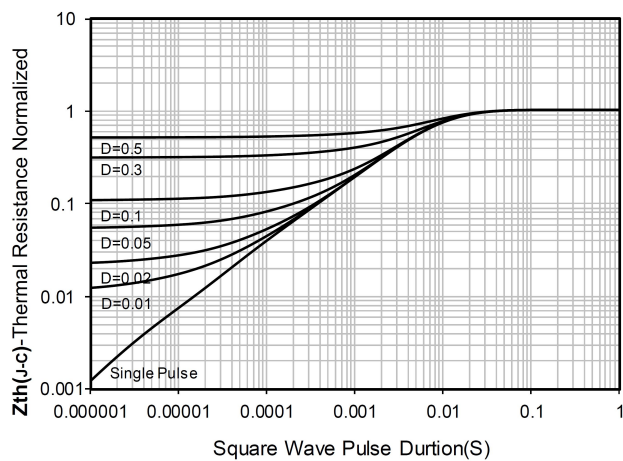
Gate Threshold voltage



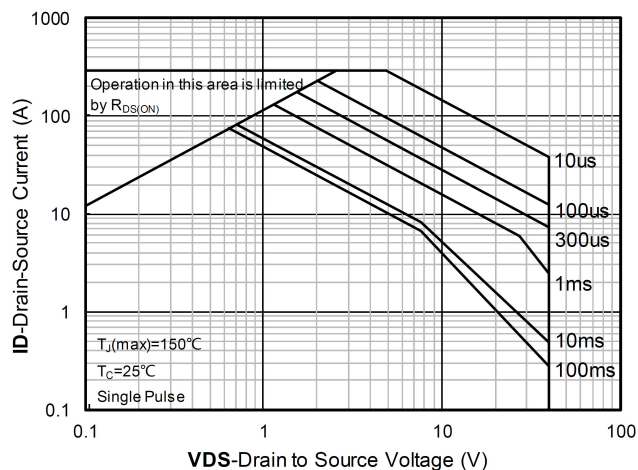
Current dissipation



Power dissipation



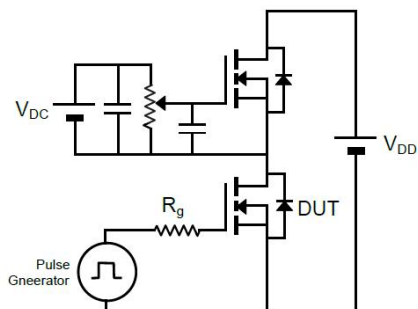
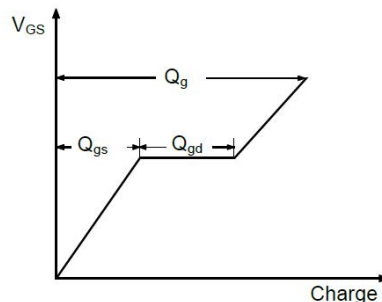
Normalized Maximum Transient Thermal Impedance



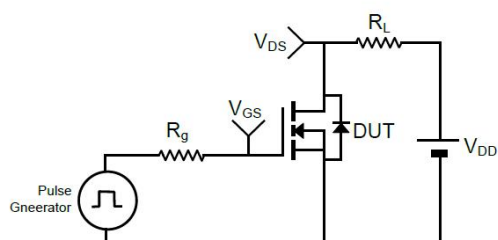
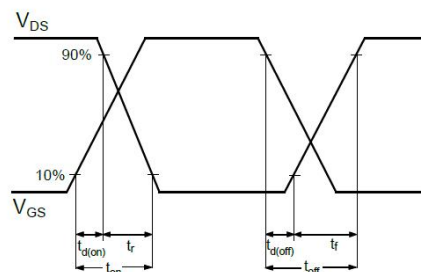
Safe Operation Area

Test Circuit

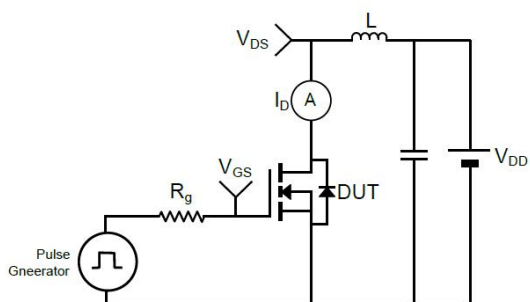
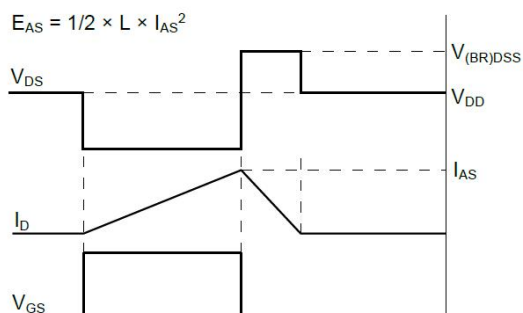
Gate Charge



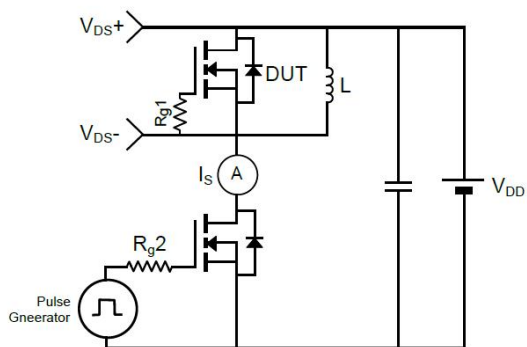
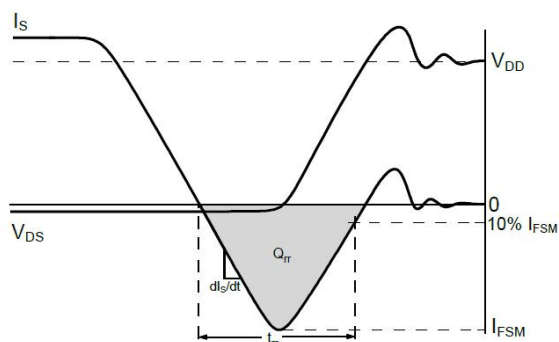
Resistive Load Switching Time



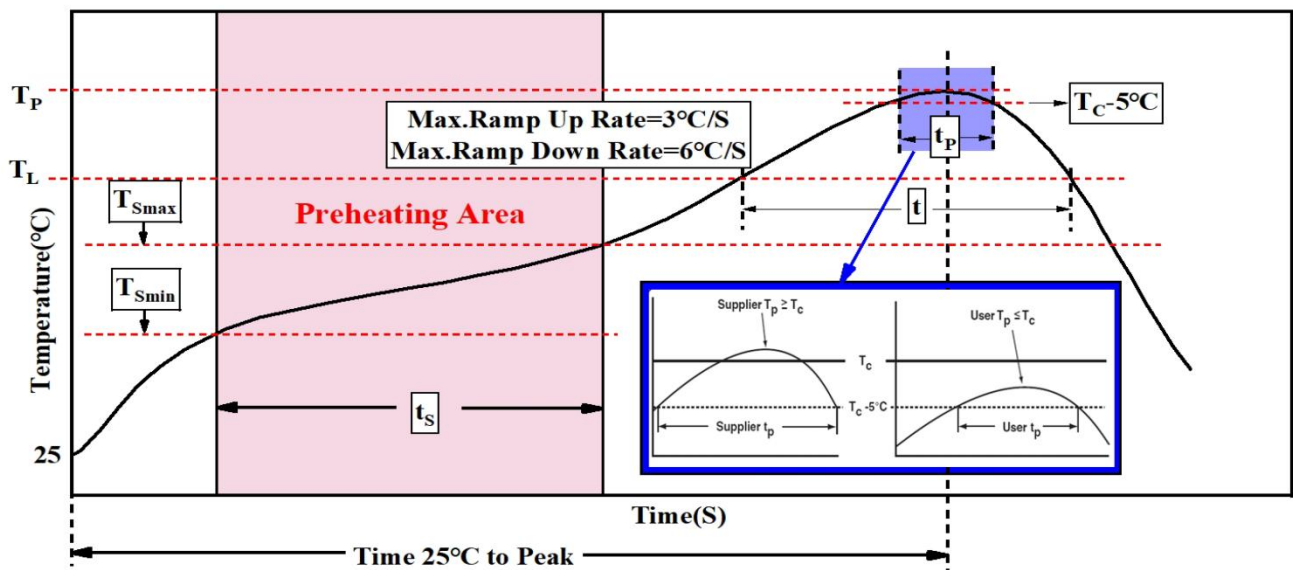
Un-clamped Inductive Load Switching



Drain-Source Body Diode Reverse Recovery



Temperature Profile for IR Reflow Soldering



Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Preheat & Soak		
Temperature min (T_{Smin})	100°C	150°C
Temperature max (T_{Smax})	150°C	200°C
Time (T_{Smin} to T_{Smax}) (t_s)	60-120 seconds	60-120 seconds
Average ramp-up rate (T_{Smax} to T_P)	3 °C/second max.	3°C/second max.
Liquidous temperature (T_L)	183 °C	217°C
Time at liquidous (t_L)	60-150 seconds	60-150 seconds
Peak package body Temperature e (T_P)*	See Classification Temp in table 1	See Classification Temp in table 2
Time (t_P)** within 5°C of the specified classification temperature (T_C)	20** seconds	30** seconds
Average ramp-down rate (T_P to T_{Smax})	6 °C/second max.	6 °C/second max.
Time 25°C to peak temperature	6 minutes max.	8 minutes max.
* Tolerance for peak profile Temperature (T_P) is defined as a supplier minimum and a user maximum. ** Tolerance for time at peak profile temperature (t_P) is defined as a supplier minimum and a user maximum		

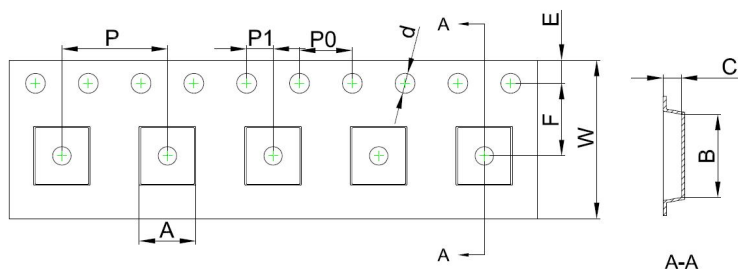
Table 1. SnPb Eutectic Process – Classification Temperatures (T_C)

Package Thickness	Volume mm ³ <350	Volume mm ³ ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2. Pb-free Process – Classification Temperatures (T_C)

Package Thickness	Volume mm ³ <350	Volume mm ³ 350-2000	Volume mm ³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

PDFN3X3-8L Reel Information



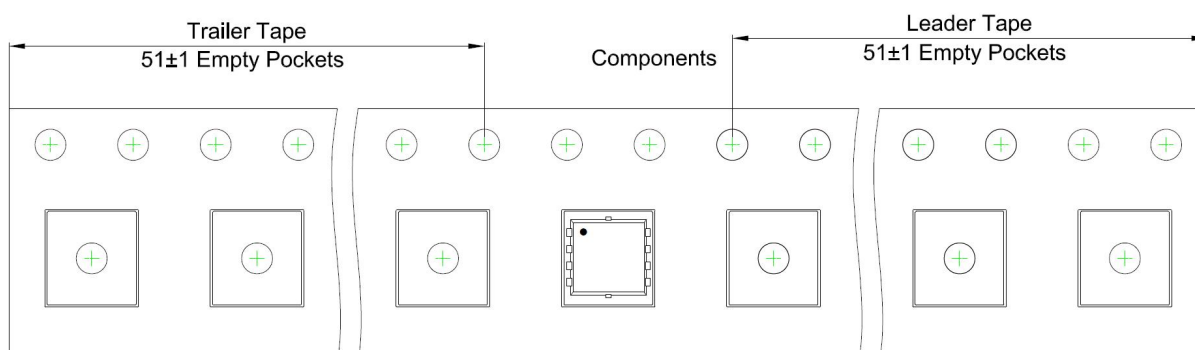
Packaging Description:

PDFN 3x3-8L parts are shipped in tape.

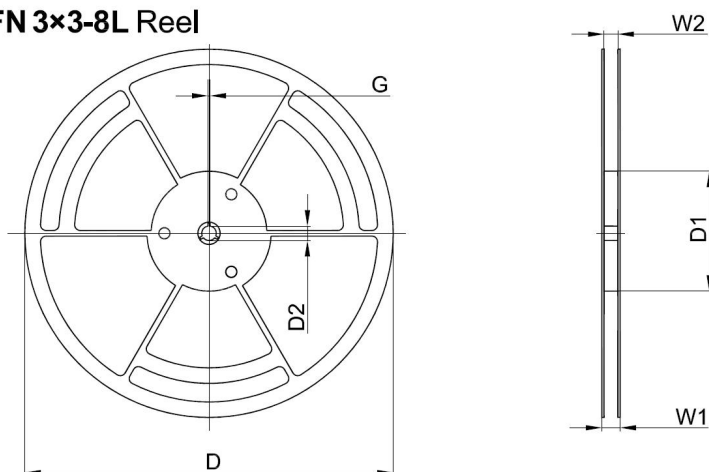
The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 5,000 units per 13" or 33.0 cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).

Dimensions are in millimeter										
Pkg type	A	B	C	d	E	F	P0	P	P1	W
PDFN3x3-8L	3.55	3.55	1.10	Ø1.50	1.75	5.50	4.00	8.00	2.00	12.00

PDFN 3x3-8L Tape Leader and Trailer



PDFN 3x3-8L Reel

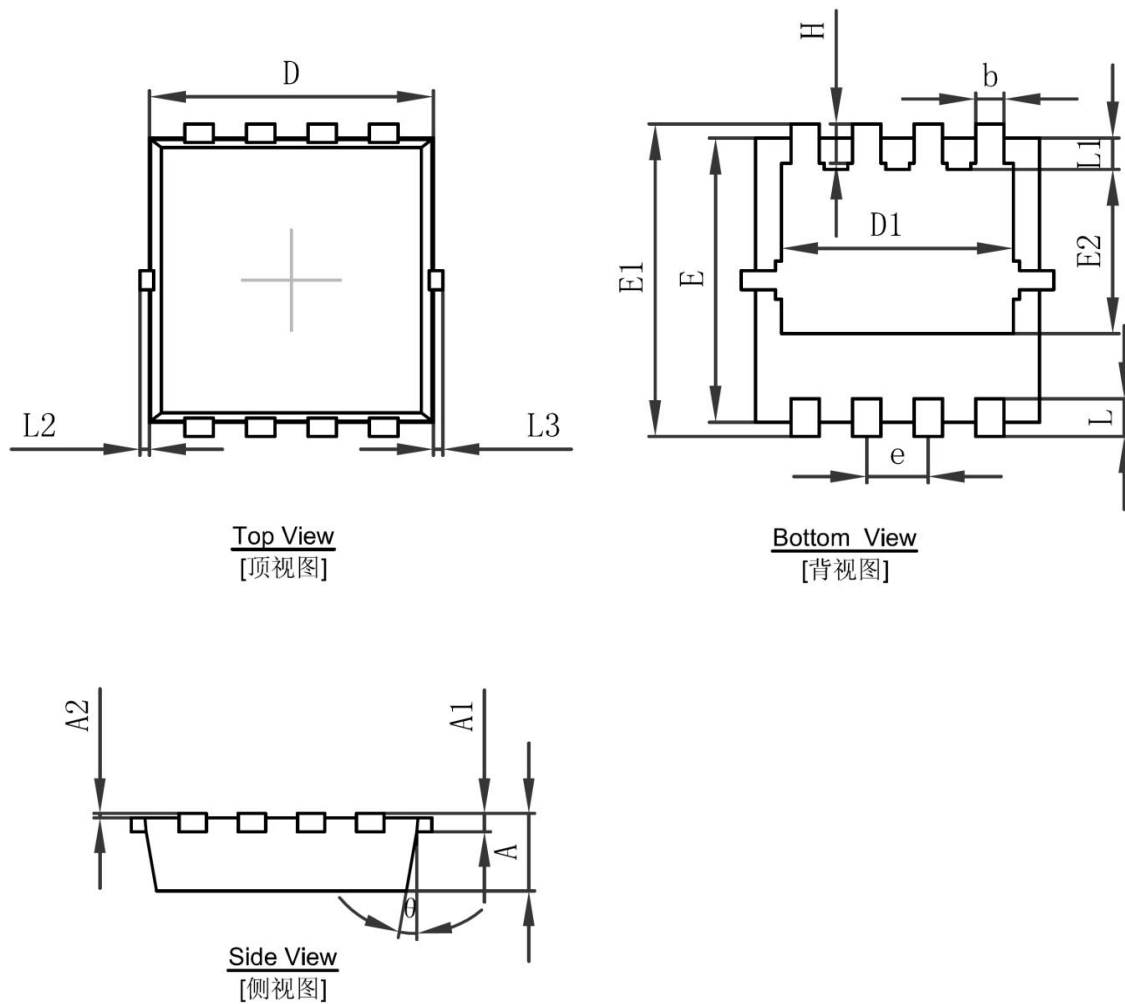


Dimensions are in millimeter						
Reel Option	D	D1	D2	G	W1	W2
13"Dia	Ø330.00	100.00	13.00	1.90	17.60	12.40

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)
5,000 pcs	13 inch	5,000 pcs	340×336×29	50,000 pcs	353×346×365



PDFN3X3-8L Package Information



Symbol	Dimensions In Millimeters	
	Min.	Max.
A	0.650	0.850
A1	0.152 REF.	
A2	0~0.05	
D	2.900	3.200
D1	2.300	2.600
E	2.900	3.100
E1	3.100	3.450
E2	1.535	1.935
b	0.200	0.400
e	0.550	0.750
L	0.300	0.500
L1	0.180	0.480
L2	0~0.100	
L3	0~0.100	
H	0.315	0.515
θ	9°	13°